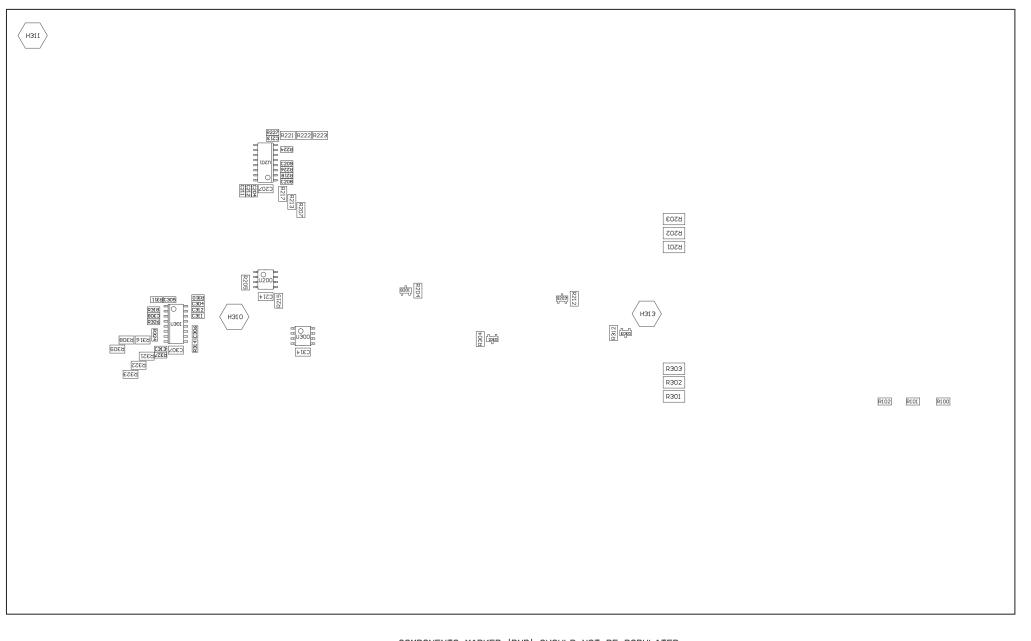


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10948	REV: A	SUN REU	Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 2/12/2	2015 3: 57: 24	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10948	REU: A	SUN REU	: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 2/12/2	2015 3:57:26	PM	TEXAS INSTRUMENTS

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